

## Features

- AEC-Q101 qualified
- Low on resistance
- Low reverse transfer capacitances
- 100% single pulse avalanche energy test
- 100% ΔVDS test
- Pb-Free plating / Halogen-Free / RoHS compliant

## Key Parameters

|                         |        |
|-------------------------|--------|
| V <sub>DS</sub>         | 100V   |
| R <sub>DS(on)typ.</sub> | 1.8mΩ  |
| V <sub>TH</sub>         | 3V     |
| I <sub>D</sub>          | 272A   |
| C <sub>iss@10V</sub>    | 7035pF |
| Q <sub>gd</sub>         | 27nC   |

## Applications

- Power switching applications
- DC-DC converters
- Full bridge control
- Automotive applications



AEC Qualified



LEAD FREE

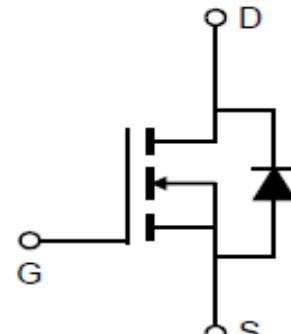
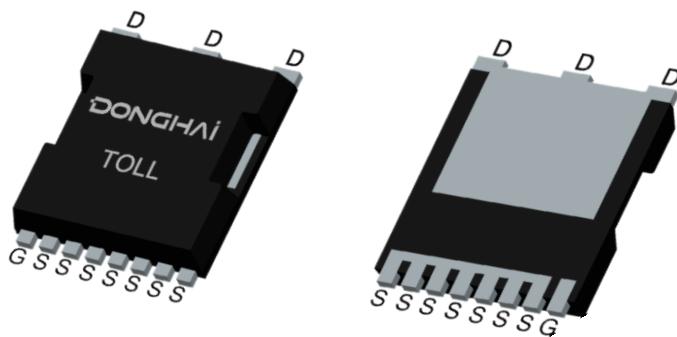


Halogen FREE



RoHS  
COMPLIANT

## TOLL



## Marking & Packing Information

| Part #       | Package | Marking      | Tube/Reel   | Qty(pcs) |
|--------------|---------|--------------|-------------|----------|
| DSU024N10N3A | TOLL    | DSU024N10N3A | Tape & Reel | 800/box  |

### Absolute Maximum Ratings

| Parameter  | Symbol                            | Value      | Unit |
|--|-----------------------------------|------------|------|
| Drain-source voltage   | V <sub>DS</sub>                   | 100        | V    |
| Gate-Source voltage  | V <sub>GS</sub>                   | ±20        | V    |
| Continuous drain current   | I <sub>D</sub>                    | 272        | A    |
| T <sub>C</sub> = 25°C  |                                   | 192        |      |
| T <sub>C</sub> = 100°C   |                                   |            |      |
| Pulsed drain current (T <sub>C</sub> = 25°C, t <sub>p</sub> limited by T <sub>jmax</sub> ) | I <sub>D</sub> pulse              | 1089       | A    |
| Avalanche energy, single pulse (L=0.5mH, R <sub>g</sub> =25Ω)                              | E <sub>AS</sub>                   | 1225       | mJ   |
| Power dissipation  | P <sub>tot</sub>                  | 375        | W    |
| T <sub>A</sub> = 25°C  |                                   | 2.3        | W    |
| Operating junction and storage temperature   | T <sub>j</sub> , T <sub>stg</sub> | -55...+175 | °C   |

### Thermal Resistance

| Parameter  | Symbol            | Max  | Unit |
|--|-------------------|------|------|
| Thermal resistance, junction – case.                   | R <sub>thJC</sub> | 0.40 | °C/W |
| Thermal resistance, junction – ambient(min. footprint) | R <sub>thJA</sub> | 65   |      |

### Electrical Characteristic (at T<sub>j</sub> = 25 °C, unless otherwise specified)

#### Static Characteristic

| Parameter                        | Symbol              | Value |      |      | Unit | Test Condition  |
|----------------------------------|---------------------|-------|------|------|------|---|
|                                  |                     | min.  | typ. | max. |      |   |
| Drain-source breakdown voltage   | BV <sub>DSS</sub>   | 100   | -    | -    | V    | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                      |
| Gate threshold voltage           | V <sub>GS(th)</sub> | 2.0   | 3.0  | 4.0  | V    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA        |
| Zero gate voltage drain current  | I <sub>DSS</sub>    | -     | -    | 1    | μA   | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V                      |
|                                  |                     | -     | -    | 100  |      | T <sub>j</sub> =25°C  |
|                                  |                     |       |      |      |      | T <sub>j</sub> =125°C   |
| Gate-source leakage current      | I <sub>GSS</sub>    | -     | -    | 100  | nA   | V <sub>GS</sub> =20V, V <sub>DS</sub> =0V                       |
| Drain-source on-state resistance | R <sub>DS(on)</sub> | -     | 1.8  | 2.2  | mΩ   | V <sub>GS</sub> =10V, I <sub>D</sub> =90A, T <sub>j</sub> =25°C |
| Transconductance                 | g <sub>fs</sub>     | -     | 186  | -    | S    | V <sub>DS</sub> =5V, I <sub>D</sub> =90A                        |

### Dynamic Characteristic

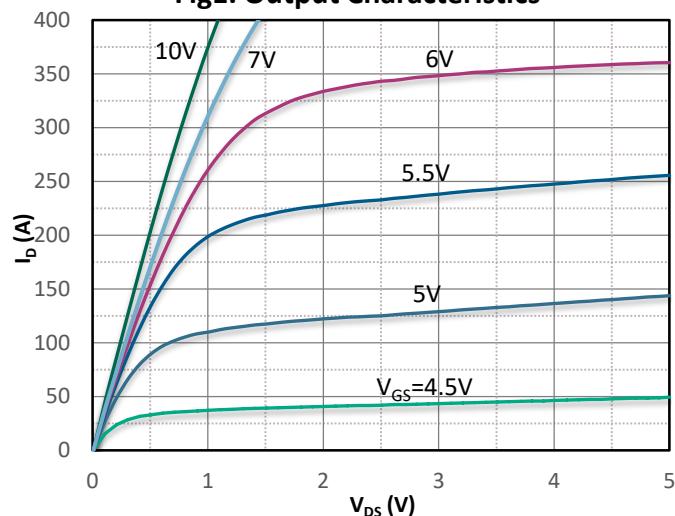
| Parameter                    | Symbol               | Value |      |      | Unit | Test Condition  |
|------------------------------|----------------------|-------|------|------|------|---|
|                              |                      | min.  | typ. | max. |      |   |
| Input Capacitance            | C <sub>iss</sub>     | -     | 7035 | -    | pF   | V <sub>GS</sub> =0V, V <sub>DS</sub> =50V,<br>f=1MHz                          |
| Output Capacitance           | C <sub>oss</sub>     | -     | 2398 | -    |      |   |
| Reverse Transfer Capacitance | C <sub>rss</sub>     | -     | 117  | -    |      |   |
| Gate Total Charge            | Q <sub>G</sub>       | -     | 107  | -    | nC   | V <sub>GS</sub> =10V, V <sub>DS</sub> =50V,<br>I <sub>D</sub> =90A            |
| Gate-Source charge           | Q <sub>gs</sub>      | -     | 37   | -    |      |   |
| Gate-Drain charge            | Q <sub>gd</sub>      | -     | 27   | -    |      |   |
| Gate plateau voltage         | V <sub>plateau</sub> | -     | 5.6  | -    | V    |   |
| Turn-on delay time           | t <sub>d(on)</sub>   | -     | 28   | -    | ns   | V <sub>GS</sub> =10V, V <sub>DD</sub> =50V,<br>ID=90A, R <sub>G_ext</sub> =3Ω |
| Rise time                    | t <sub>r</sub>       | -     | 108  | -    |      |   |
| Turn-off delay time          | t <sub>d(off)</sub>  | -     | 56   | -    |      |   |
| Fall time                    | t <sub>f</sub>       | -     | 124  | -    |      |   |
| Gate resistance              | R <sub>G</sub>       | -     | 1.8  | -    | Ω    | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V,<br>f=1MHz                           |

### Body Diode Characteristic

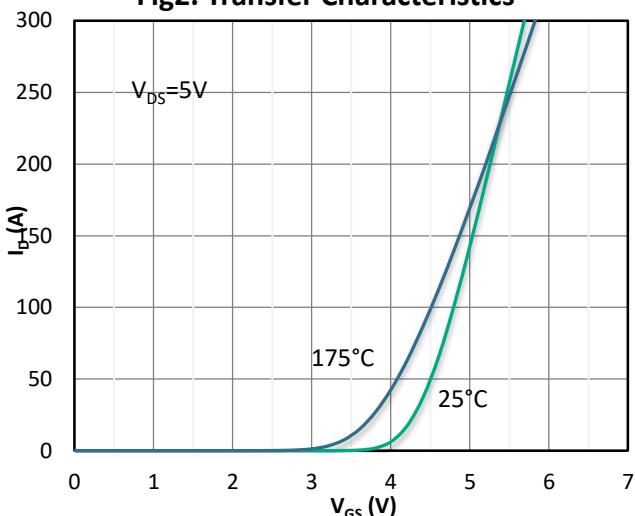
| Parameter                     | Symbol          | Value |      |      | Unit | Test Condition                            |
|-------------------------------|-----------------|-------|------|------|------|---|
|                               |                 | min.  | typ. | max. |      |   |
| Diode Max Current             | I <sub>S</sub>  |       | -    | 272  | A    | -   |
| Diode Forward Voltage         | V <sub>SD</sub> | -     | -    | 1.2  | V    | V <sub>GS</sub> =0V, I <sub>SD</sub> =90A |
| Diode Reverse Recovery Time   | t <sub>rr</sub> | -     | 107  | -    | ns   | I <sub>F</sub> =90A,<br>dI/dt=100A/μs     |
| Diode Reverse Recovery Charge | Q <sub>rr</sub> | -     | 143  | -    |      |   |

### Typical Characteristics Diagram

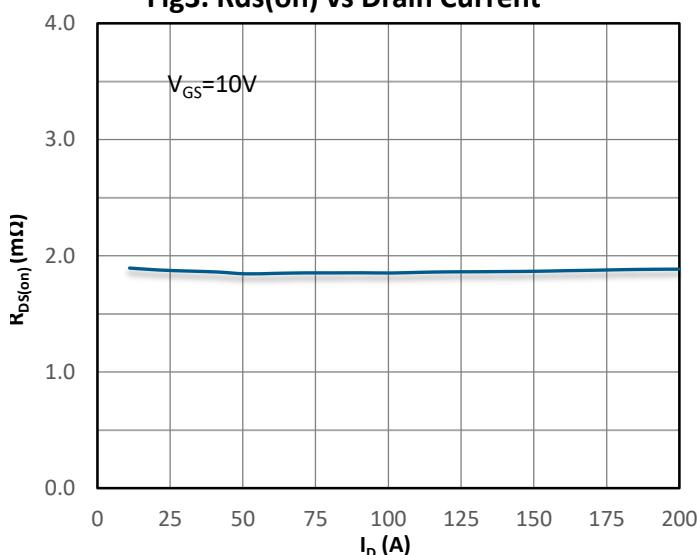
**Fig1. Output Characteristics**



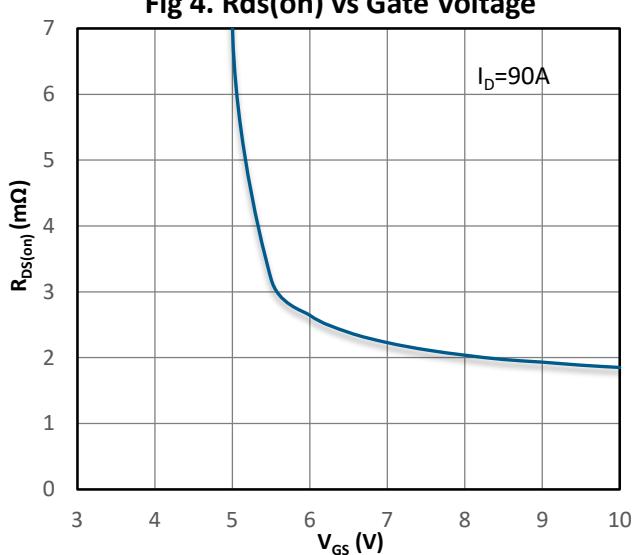
**Fig2. Transfer Characteristics**



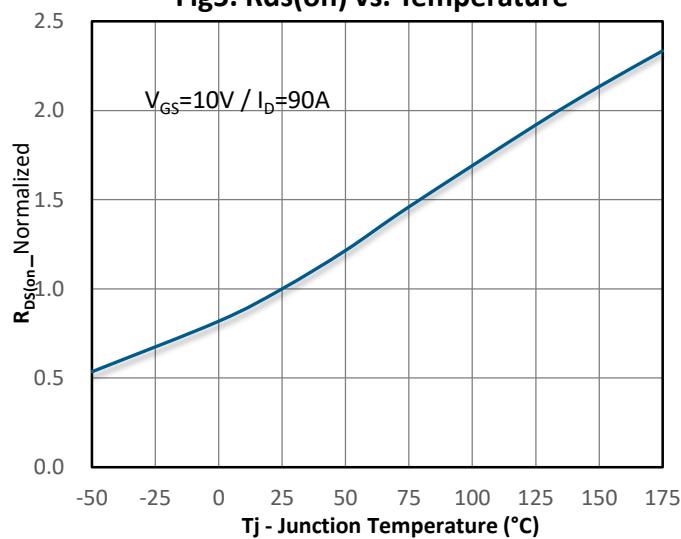
**Fig3. R<sub>d</sub>s(on) vs Drain Current**



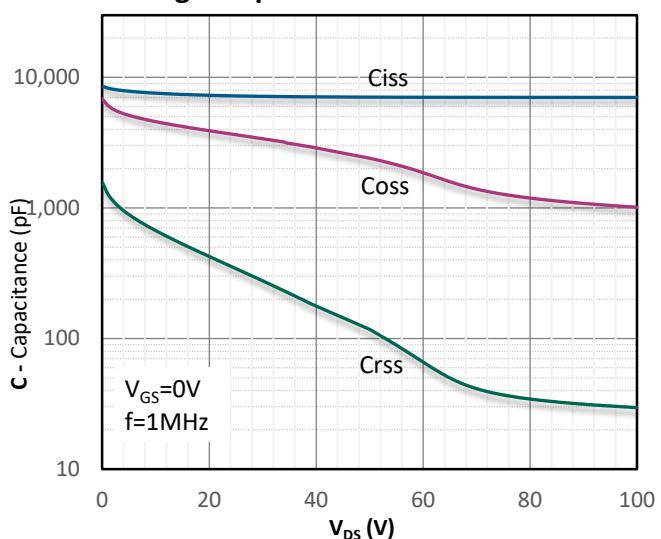
**Fig 4. R<sub>d</sub>s(on) vs Gate Voltage**



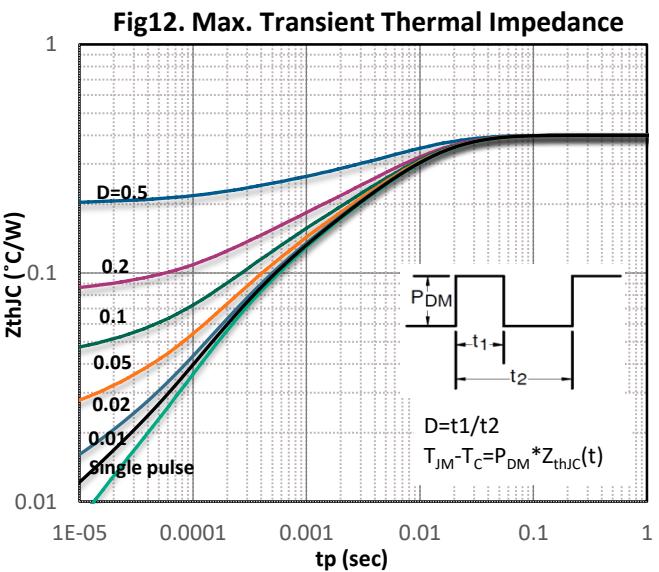
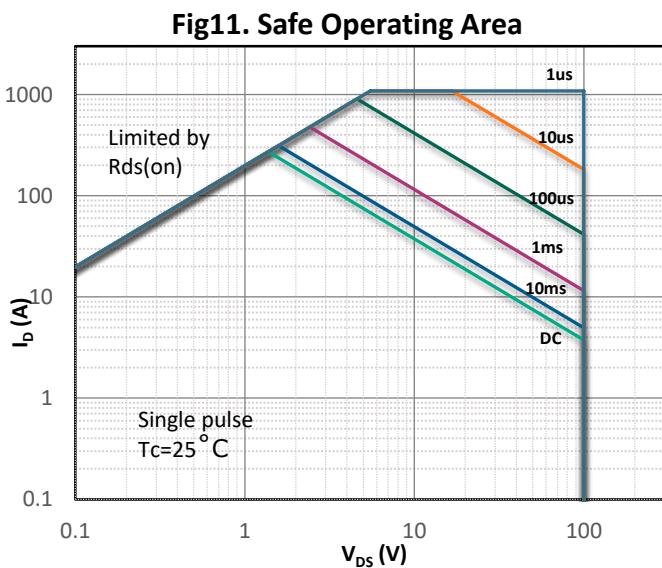
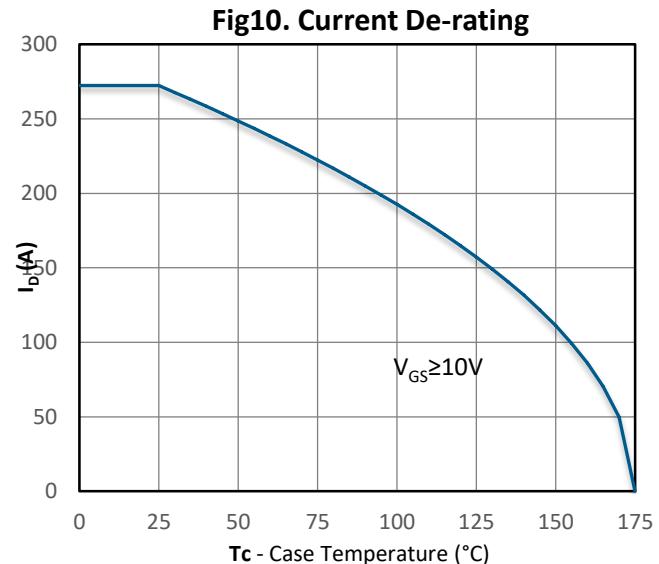
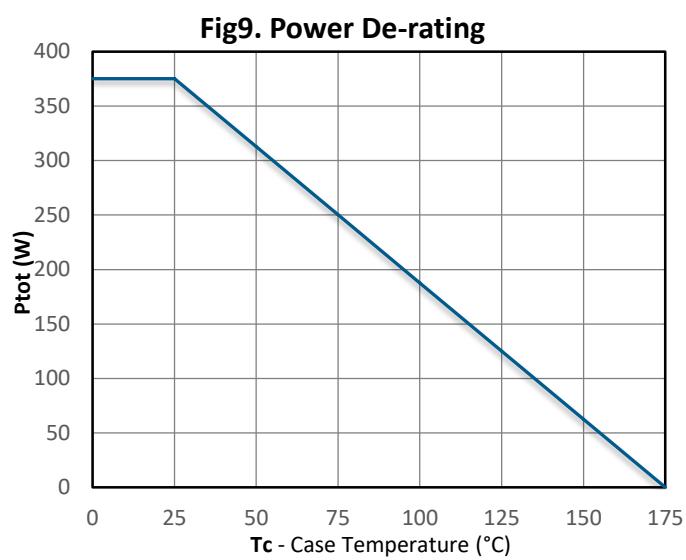
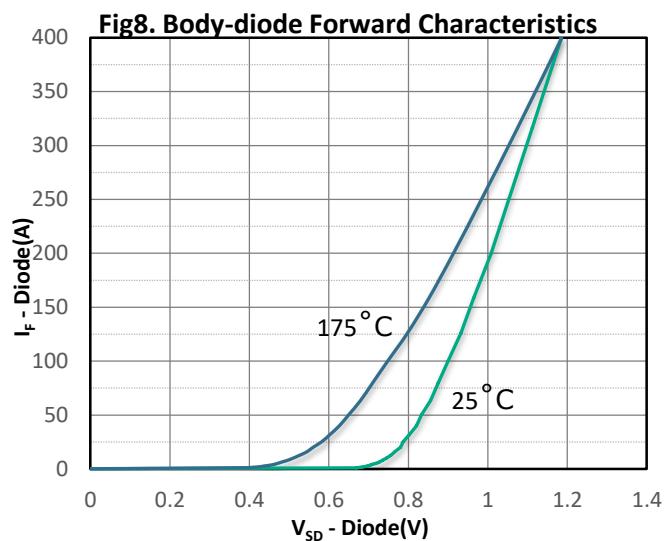
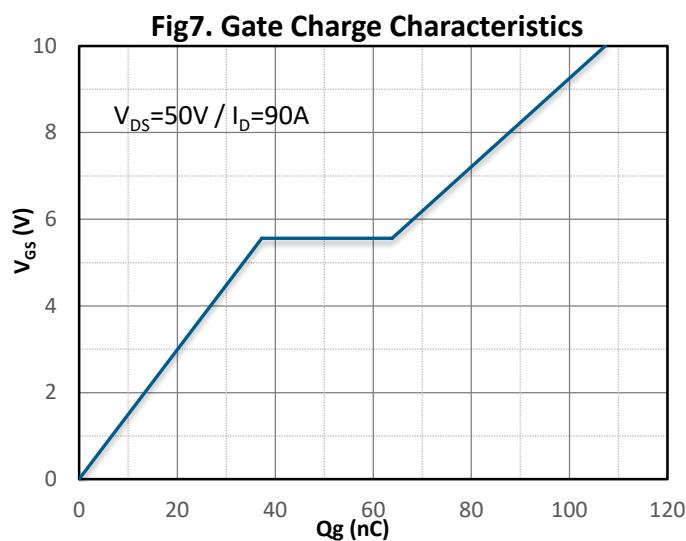
**Fig5. R<sub>d</sub>s(on) vs. Temperature**



**Fig6. Capacitance Characteristics**

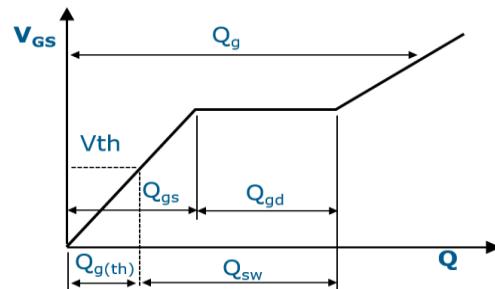
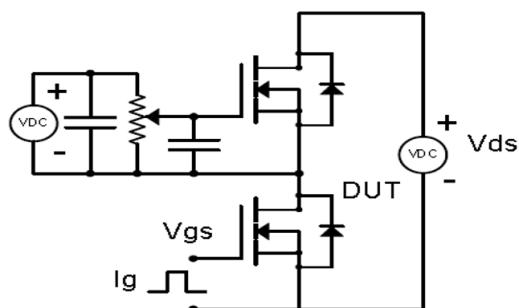


### Typical Characteristics Diagram

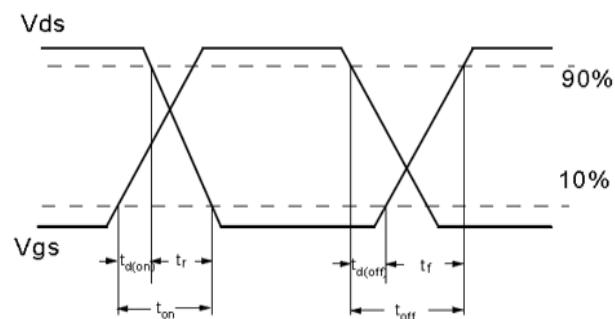
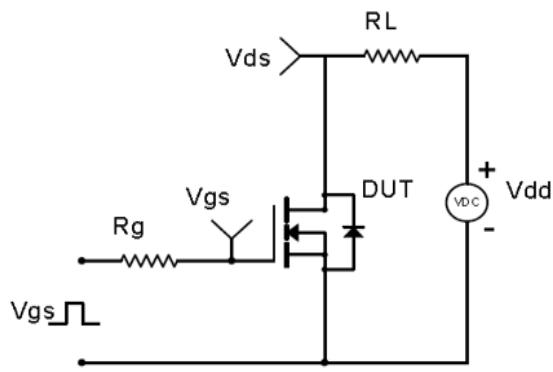


### Test Circuit & Waveform

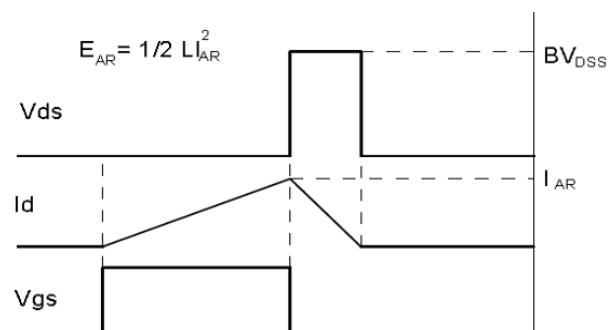
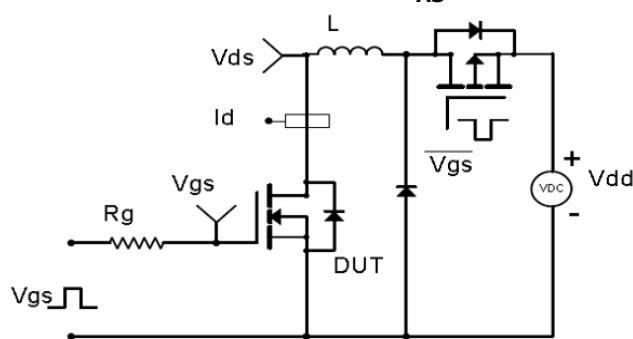
#### Gate Charge Test Circuit & Waveform



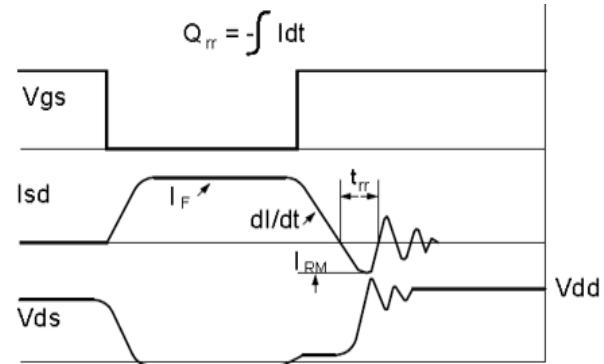
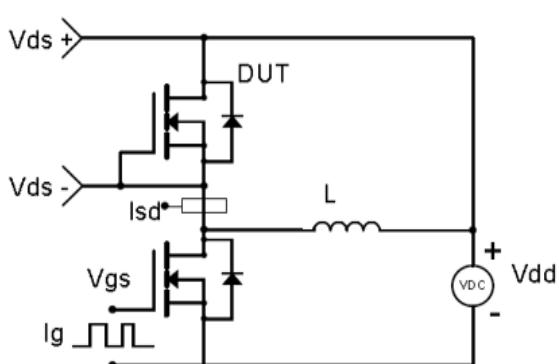
#### MOSFET Switching Test Circuit & Waveform



#### E<sub>AS</sub> Test Circuit & Waveform

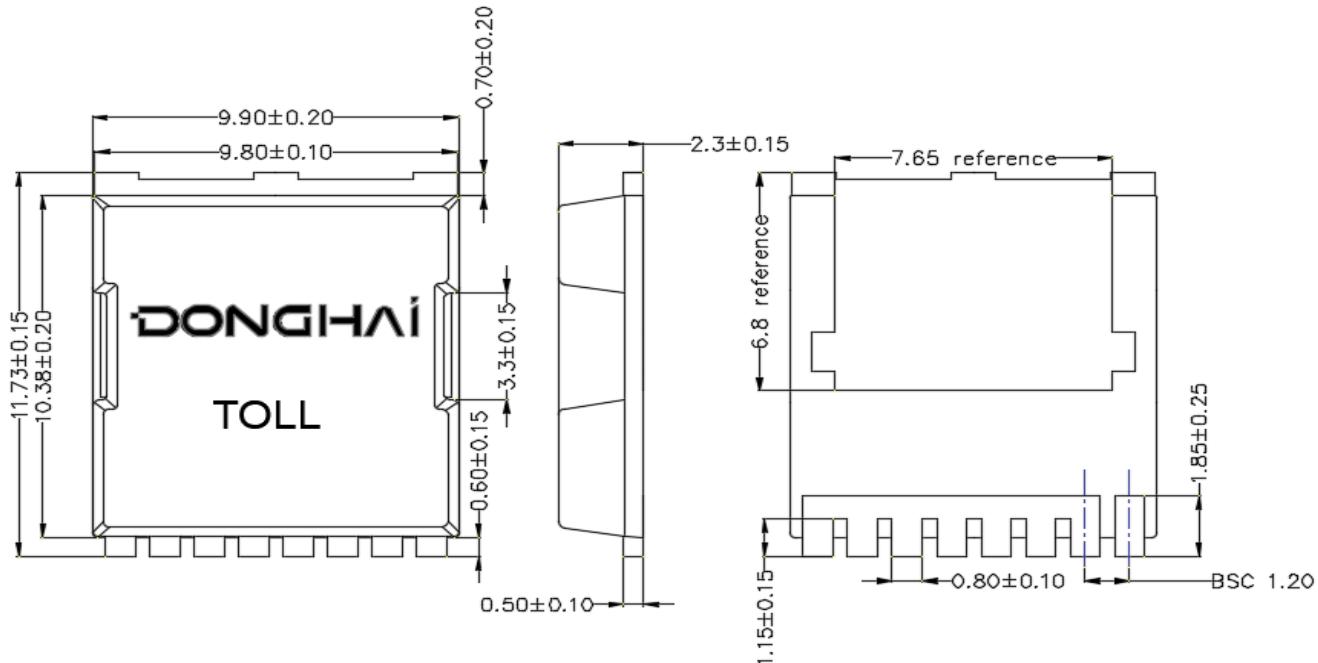


#### Diode Recovery Test Circuit & Waveform



### Package Outline : TOLL

\*Dimensions in mm



### Revision History

| Revison | Date       | Major changes             |
|---------|------------|---------------------------|
| 1.0     | 2023/10/23 | Release of formal version |

### Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as aviation, aerospace, life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are responsible for providing adequate safe measures when design their systems.

DONGHAI Semiconductor reserves the right to improve product design, function, reliability without notice. Copy Rights@Jiangsu Donghai Semiconductor Co. Ltd.